

# Thyristor Modules

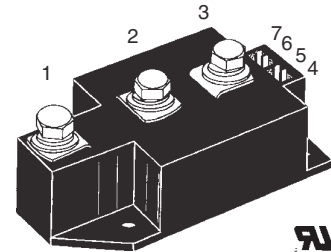
## Thyristor/Diode Modules

$$I_{TRMS} = 2 \times 450 \text{ A}$$

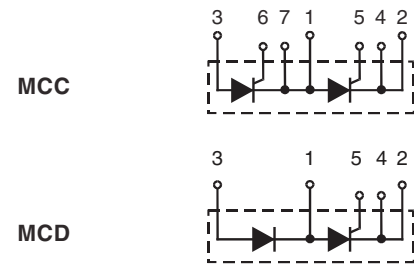
$$I_{TAVM} = 2 \times 287 \text{ A}$$

$$V_{RRM} = 800-1800 \text{ V}$$

| $V_{RSM}$<br>$V_{DSM}$<br>V | $V_{RRM}$<br>$V_{DRM}$<br>V | Type          | Version 1     | Version 1     |
|-----------------------------|-----------------------------|---------------|---------------|---------------|
| 900                         | 800                         | MCC 250-08io1 | MCC 250-08io1 | MCD 250-08io1 |
| 1300                        | 1200                        | MCC 250-12io1 | MCC 250-12io1 | MCD 250-12io1 |
| 1500                        | 1400                        | MCC 250-14io1 | MCC 250-14io1 | MCD 250-14io1 |
| 1700                        | 1600                        | MCC 250-16io1 | MCC 250-16io1 | MCD 250-16io1 |
| 1900                        | 1800                        | MCC 250-18io1 | MCC 250-18io1 | MCD 250-18io1 |



| Symbol                                       | Conditions   | Maximum Ratings   |                                       |
|--|--|---|---------------------------------------|
| $I_{TRMS}, I_{FRMS}$<br>$I_{TAVM}, I_{FAVM}$ | $T_{VJ} = T_{VJM}$<br>$T_C = 85^\circ\text{C}; 180^\circ \text{ sine}$                   | 450   | A                                     |
| $I_{TSM}, I_{FSM}$                           | $T_{VJ} = 45^\circ\text{C}$<br>$V_R = 0$   | $t = 10 \text{ ms (50 Hz), sine}$<br>$t = 8.3 \text{ ms (60 Hz), sine}$ | 9000<br>9600<br>A<br>A                |
| $\int i^2 dt$                                | $T_{VJ} = 45^\circ\text{C}$<br>$V_R = 0$   | $t = 10 \text{ ms (50 Hz), sine}$                                       | 405 000 $\text{A}^2\text{s}$          |
|  |  | $t = 8.3 \text{ ms (60 Hz), sine}$                                      | 380 000 $\text{A}^2\text{s}$          |
| $(di/dt)_{cr}$                               | $T_{VJ} = T_{VJM};$<br>$f = 50 \text{ Hz}; t_p = 200 \mu\text{s}$<br>$V_D = 2/3 V_{DRM}$ | repetitive, $I_T = 860 \text{ A}$                                       | 100 $\text{A}/\mu\text{s}$            |
|  |  | $I_G = 1 \text{ A};$<br>$di_G/dt = 1 \text{ A}/\mu\text{s}$             | non repetitive, $I_T = 290 \text{ A}$ |
| $(dv/dt)_{cr}$                               | $T_{VJ} = T_{VJM};$<br>$R_{GK} = \infty; \text{ method 1 (linear voltage rise)}$         | $V_{DR} = 2/3 V_{DRM}$  | 1000 $\text{V}/\mu\text{s}$           |
| $P_{GM}$                                     | $T_{VJ} = T_{VJM};$<br>$I_T = I_{TAVM};$   | $t_p = 30 \mu\text{s}$<br>$t_p = 500 \mu\text{s}$                       | 120 W<br>60 W                         |
| $P_{GAV}$                                    |  |   | 20 W                                  |
| $V_{RGM}$                                    |  |   | 10 V                                  |
| $T_{VJ}$                                     |  |   | -40...+140 $^\circ\text{C}$           |
| $T_{VJM}$                                    |  |   | 140 $^\circ\text{C}$                  |
| $T_{stg}$                                    |  |   | -40...+125 $^\circ\text{C}$           |
| $V_{ISOL}$                                   | 50/60 Hz, RMS;<br>$I_{ISOL} \leq 1 \text{ mA};$  | $t = 1 \text{ min}$   | 3000 V~                               |
|  |  | $t = 1 \text{ s}$   | 3600 V~                               |
| $M_d$  | Mounting torque (M5)   |   | 2.5-5/22-44 Nm/lb.in.                 |
|  | Terminal connection torque (M8)  |   | 12-15/106-132 Nm/lb.in.               |
| <b>Weight</b>                                | Typical including screws   |   | 320 g                                 |



### Features

- International standard package
- Direct copper bonded  $\text{Al}_2\text{O}_3$ -ceramic base plate
- Planar passivated chips
- Isolation voltage 3600 V~
- UL registered, E 72873
- Keyed gate/cathode twin pins

### Applications

- Motor control
- Power converter
- Heat and temperature control for industrial furnaces and chemical processes
- Lighting control
- Contactless switches

### Advantages

- Space and weight savings
- Simple mounting
- Improved temperature and power cycling
- Reduced protection circuits

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated. IXYS reserves the right to change limits, test conditions and dimensions

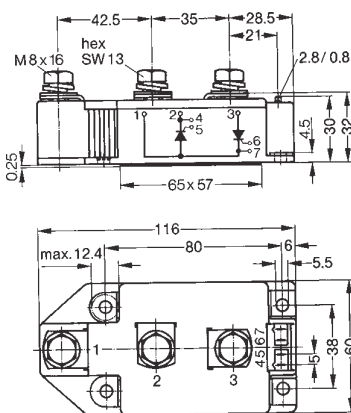
| Symbol     | Conditions  | Characteristic Values  |
|------------|---|------------------------|
| $I_{RRM}$  | $T_{VJ} = T_{VJM}; V_R = V_{RRM}; V_D = V_{DRM}$  | 70 mA                  |
| $I_{DRM}$  |   | 40 mA                  |
| $V_T, V_F$ | $I_T/I_F = 600 \text{ A}; T_{VJ} = 25^\circ\text{C}$  | 1.36 V                 |
| $V_{T0}$   | For power-loss calculations only ( $T_{VJ} = 140^\circ\text{C}$ )   | 0.85 V                 |
| $r_T$      |   | 0.82 m $\Omega$        |
| $V_{GT}$   | $V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$  | 2 V                    |
|            | $T_{VJ} = -40^\circ\text{C}$  | 3 V                    |
| $I_{GT}$   | $V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$  | 150 mA                 |
|            | $T_{VJ} = -40^\circ\text{C}$  | 200 mA                 |
| $V_{GD}$   | $T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$   | 0.25 V                 |
| $I_{GD}$   |   | 10 mA                  |
| $I_L$      | $T_{VJ} = 25^\circ\text{C}; t_p = 30 \mu\text{s}; V_D = 6 \text{ V}$<br>$I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A}/\mu\text{s}$  | 200 mA                 |
| $I_H$      | $T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; R_{GK} = \infty$   | 150 mA                 |
| $t_{gd}$   | $T_{VJ} = 25^\circ\text{C}; V_D = 1/2 V_{DRM}$<br>$I_G = 1 \text{ A}; di_G/dt = 1 \text{ A}/\mu\text{s}$  | 2 $\mu\text{s}$        |
| $t_q$      | $T_{VJ} = T_{VJM}; I_T = 300 \text{ A}, t_p = 200 \mu\text{s}; -di/dt = 10 \text{ A}/\mu\text{s}$<br>$V_R = 100 \text{ V}; dv/dt = 50 \text{ V}/\mu\text{s}; V_D = 2/3 V_{DRM}$ | typ. 200 $\mu\text{s}$ |
| $Q_S$      | $T_{VJ} = 125^\circ\text{C}; I_T/I_F = 400 \text{ A}, -di/dt = 50 \text{ A}/\mu\text{s}$  | 760 $\mu\text{C}$      |
| $I_{RM}$   |   | 275 A                  |
| $R_{thJC}$ | per thyristor/diode; DC current per module  | 0.129 KW               |
| $R_{thJK}$ | per thyristor/diode; DC current per module  | 0.0645 KW              |
|            | other values see Fig. 8/9   | 0.169 KW               |
|            |   | 0.0845 KW              |
| $d_S$      | Creepage distance on surface  | 12.7 mm                |
| $d_A$      | Strike distance through air   | 9.6 mm                 |
| $a$        | Maximum allowable acceleration  | 50 m/s <sup>2</sup>    |

Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = yellow, cathode = red  
 Type **ZY 180L** (L = Left for pin pair 4/5) } UL 758, style 1385,  
 Type **ZY 180R** (R = right for pin pair 6/7) } CSA class 5851, guide 460-1-1

### Dimensions in mm (1 mm = 0.0394")

#### MCC



#### MCD

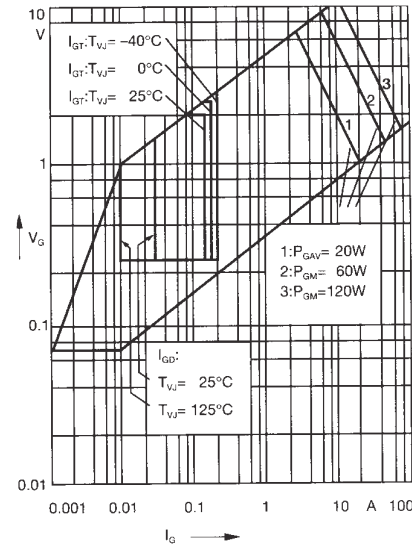
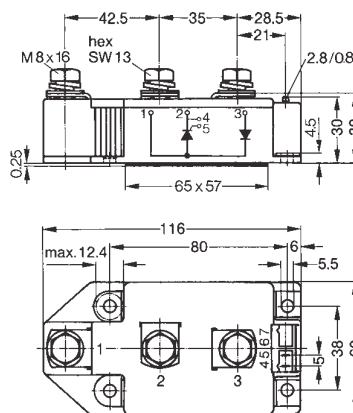


Fig. 1 Gate trigger characteristics

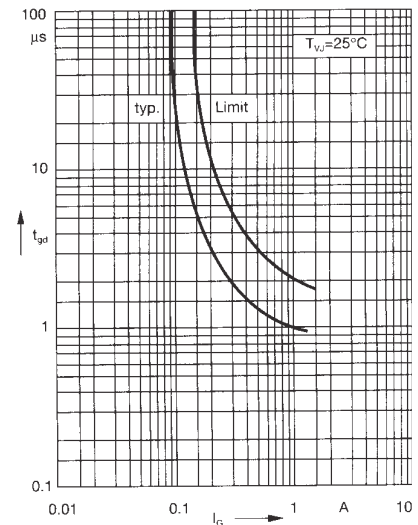
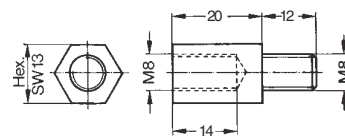


Fig. 2 Gate trigger delay time

Threaded spacer for higher Anode/Cathode construction:  
 Type **ZY 250**, material brass



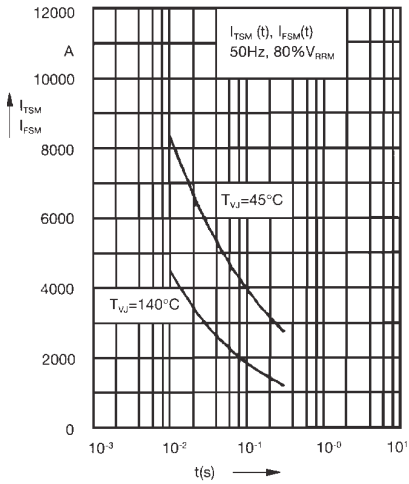


Fig. 3 Surge overload current  
 $I_{TSM}, I_{FSM}$ : Crest value,  $t$ : duration

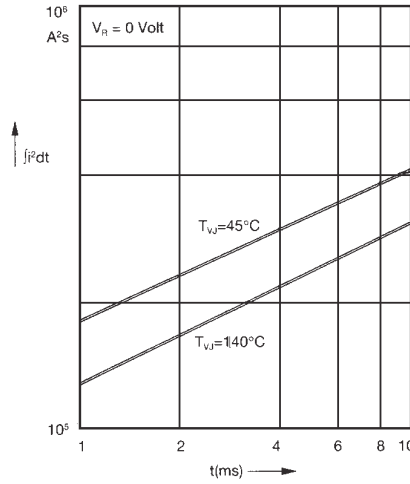


Fig. 4  $\int j^2 dt$  versus time (1-10 ms)

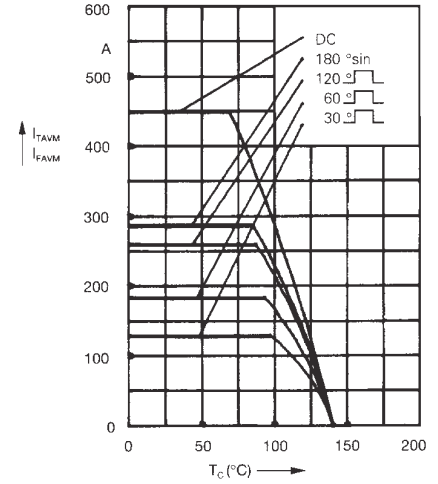


Fig. 4a Maximum forward current at case temperature

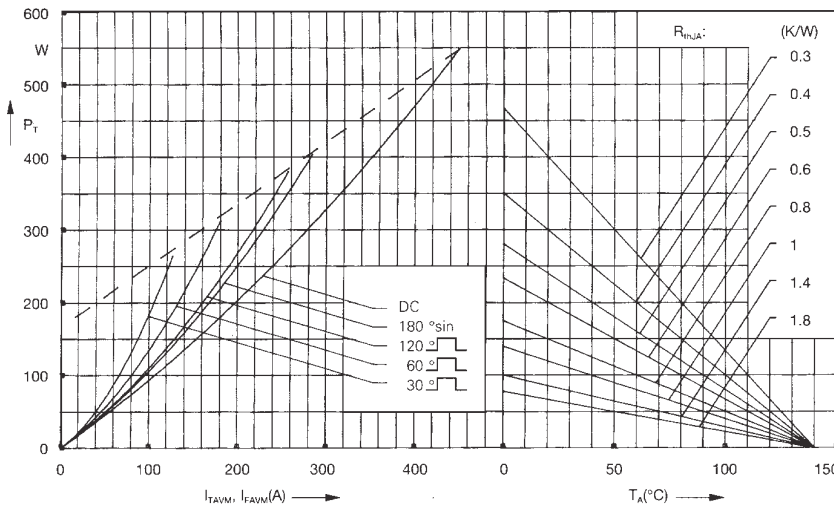


Fig. 5 Power dissipation versus on-state current and ambient temperature (per thyristor or diode)

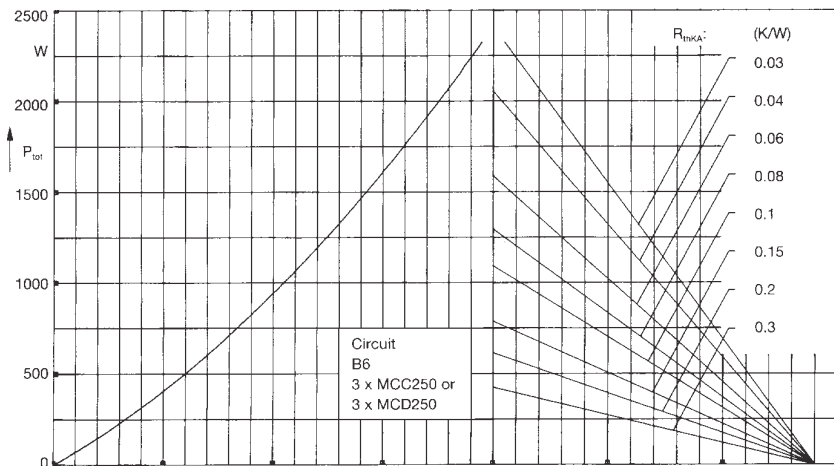


Fig. 6 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

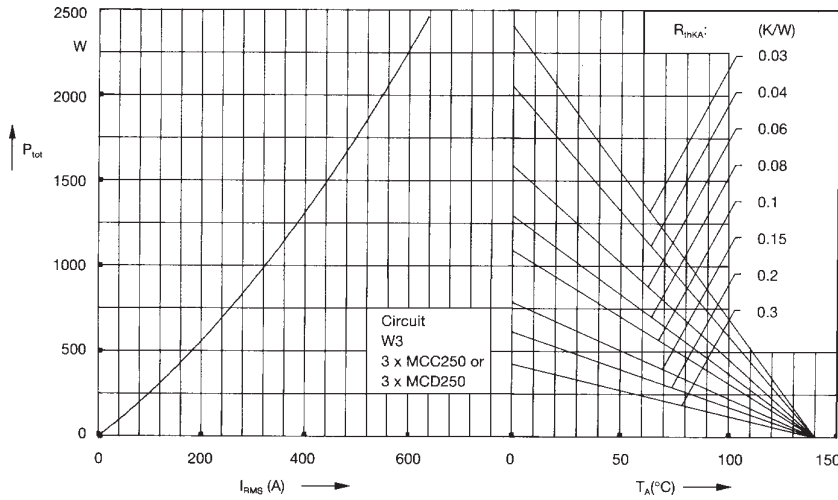


Fig. 7 Three phase AC-controller:  
Power dissipation versus RMS  
output current and ambient  
temperature

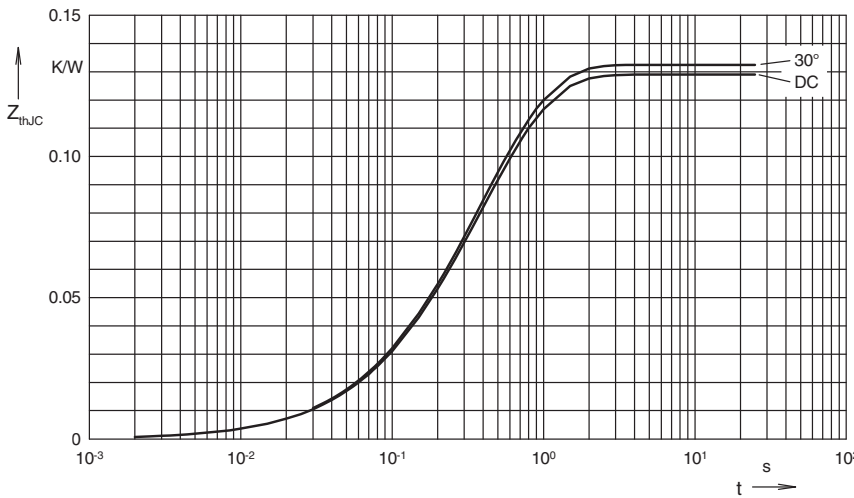


Fig. 8 Transient thermal impedance  
junction to case (per thyristor or  
diode)

$R_{thJC}$  for various conduction angles d:

| d     | $R_{thJC}$ (K/W) |
|-------|------------------|
| DC    | 0.129            |
| 180°C | 0.131            |
| 120°C | 0.131            |
| 60°C  | 0.132            |
| 30°C  | 0.132            |

Constants for  $Z_{thJC}$  calculation:

| i | $R_{thi}$ (K/W) | $t_i$ (s) |
|---|-----------------|-----------|
| 1 | 0.0035          | 0.099     |
| 2 | 0.0165          | 0.168     |
| 3 | 0.1091          | 0.456     |

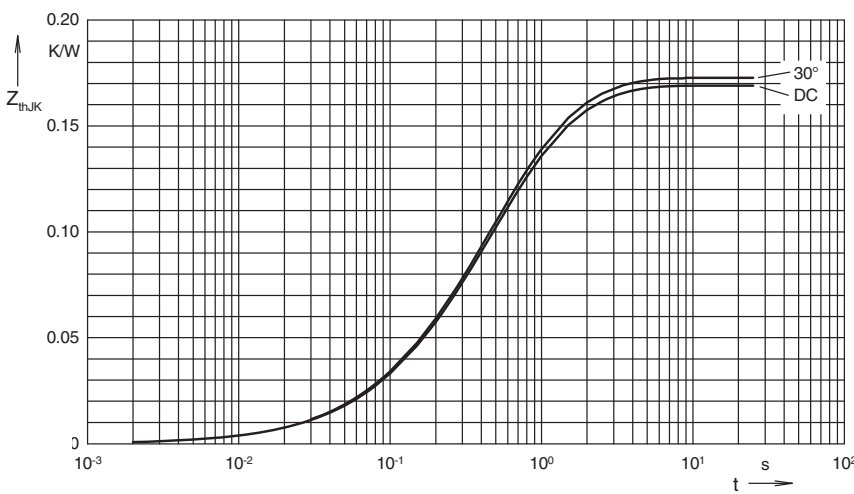


Fig. 9 Transient thermal impedance  
junction to heatsink (per thyristor  
or diode)

$R_{thJK}$  for various conduction angles d:

| d     | $R_{thJK}$ (K/W) |
|-------|------------------|
| DC    | 0.169            |
| 180°C | 0.171            |
| 120°C | 0.172            |
| 60°C  | 0.172            |
| 30°C  | 0.173            |

Constants for  $Z_{thJK}$  calculation:

| i | $R_{thi}$ (K/W) | $t_i$ (s) |
|---|-----------------|-----------|
| 1 | 0.0033          | 0.099     |
| 2 | 0.0159          | 0.168     |
| 3 | 0.1053          | 0.456     |
| 4 | 0.04            | 1.36      |